# PC814 Series

Lead forming type (I type ) and taping reel type (P type ) are also available. (**PC814I/PC814P**)

## Features

- 1. AC input
- 2. High isolation voltage between input and output (  $V: 5\ 000V_{rms}$  )
- 3. Compact dual-in-line package **PC814** (1-channel type)
  - PC824 (2-channel type)
  - PC844 (4-channel type)
- 4. Current transfer ratio CTR : MIN. 20% at  $I_F = \pm 1mA$ ,  $V_{CE} = 5V$
- 5. Recognized by UL, file No. E64380

## Applications

1. Programmable controllers

16 15 14 13

123456

1357 Anode, Cathode

2468 Anode, Cathode 9036 Emitter 0246 Collector

63

PC844

4 5

 $19.82 \pm 0.5$ 

- 2. Telephone sets, telephone exchangers
- 3. System appliances

1 2 3

CTR rank mark

**PC844** 

4. Signal transmission between circuits of different potentials and impedances

Internal connection diagram

12 ft (0 (9)

78

 $1.2^{\pm\,0.3}$ 

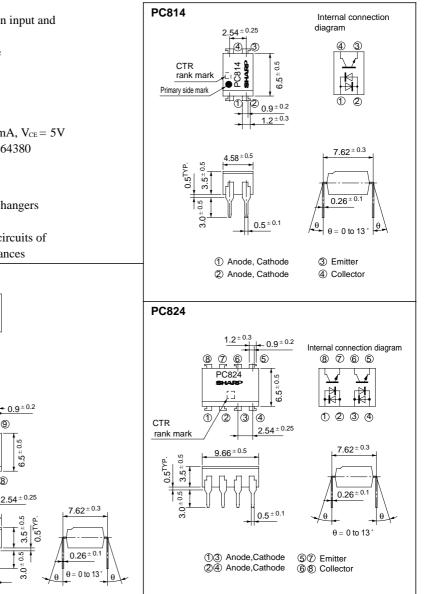
 $0.5 \pm 0$ 

0 8

## Outline Dimensions

**AC Input Photocoupler** 

(Unit: mm)



<sup>11</sup> In the absence of confirmation by device specification sheets, SHARP takes no responsibility for any defects that occur in equipment using any of SHARP's devices, shown in catalogs, data books, etc. Contact SHARP in order to obtain the latest version of the device specification sheets before using any SHARP's device."

## ■ Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$ 

|                     | Parameter                   | Symbol | Rating        | Unit  |  |
|---------------------|-----------------------------|--------|---------------|-------|--|
| Input               | Forward current             | IF     | ± 50          | mA    |  |
|                     | *1Peak forward current      | IFM    | ± 1           | А     |  |
|                     | Power dissipation           | Р      | 70            | mW    |  |
|                     | Collector-emitter voltage   | V CEO  | 35            | V     |  |
| Outrout             | Emitter-collector voltage   | V ECO  | 6             | V     |  |
| Output              | Collector current           | Ic     | 50            | mA    |  |
|                     | Collector power dissipation | Pc     | 150           | mW    |  |
|                     | Total power dissipation     | P tot  | 200           | mW    |  |
|                     | *2Isolation voltage         | V iso  | 5 000         | V rms |  |
|                     | Operating temperature       | T opr  | - 30 to + 100 | °C    |  |
| Storage temperature |                             | T stg  | - 55 to + 125 | °C    |  |
|                     | *3Soldering temperature     | T sol  | 260           | °C    |  |

\*1 Pulse width <= 100 µs, Duty ratio : 0.001

\*2 40 to 60% RH, AC for 1 minute

\*3 For 10 seconds

## ■ Electro-optical Characteristics

| Electro-optical Characteristics  |                                      |           |                 |  |                      |      |        | (Ta= 25°C) |  |
|----------------------------------|--------------------------------------|-----------|-----------------|--|----------------------|------|--------|------------|--|
| Parameter                        |                                      | Symbol    | Conditions      | MIN.   | TYP.                 | MAX. | Unit   |            |  |
|                                  | Forward voltage                      |           | VF              | $I_F = \pm \ 20 mA$  | -                    | 1.2  | 1.4    | V          |  |
| Input                            | Peak forward voltage                 |           | V <sub>FM</sub> | $I_{FM}=\pm \ 0.5 V$   | -                    | -    | 3.0    | V          |  |
|                                  | Terminal capacitance                 |           | Ct              | V = 0, f = 1kHz  | -                    | 50   | 250    | pF         |  |
| Output                           | Collector dark current               |           | ICEO            | $V_{CE} = 20V, I_F = 0$  | -                    | -    | 10 - 7 | А          |  |
| Transfer<br>charac-<br>teristics | *4Current transfer ratio             |           | CTR             | $I_F = \pm 1 m A$ , $V_{CE} = 5 V$                             | 20                   | -    | 300    | %          |  |
|                                  | Collector-emitter saturation voltage |           | V CE(sat)       | $I_F = \pm 20 \text{mA}, I_C = 1 \text{mA}$                    | -                    | 0.1  | 0.2    | V          |  |
|                                  | Isolation resistance                 |           | R ISO           | DC500V, 40 to 60% RH   | 5 x 10 <sup>10</sup> | 1011 | -      | Ω          |  |
|                                  | Floating capacitance                 |           | Cf              | V = 0, f = 1MHz  | -                    | 0.6  | 1.0    | pF         |  |
|                                  | Cut-off frequency                    |           | fc              | $V_{CE}$ = 5V, I $_{C}$ = 2mA, R $_{L}$ = 100 $\Omega,~$ - 3dB | 15                   | 80   | -      | kHz        |  |
|                                  | Response time                        | Rise time | tr              | $V_{CE} = 2V, I_{C} = 2mA, R_{L} =$                            | -                    | 4    | 18     | μs         |  |
|                                  |                                      | Fall time | tf              | 100 Ω  | -                    | 3    | 18     | μs         |  |

\*4 Classification table of current transfer ratio

| Model No. | Rank mark    | CTR (%)   |  |  |
|-----------|--------------|-----------|--|--|
| PC814A    |              |           |  |  |
| PC824A    | A            | 50 to 150 |  |  |
| PC844A    |              |           |  |  |
| PC814     |              | 20 to 300 |  |  |
| PC824     | A or no mark |           |  |  |
| PC844     |              |           |  |  |

Fig. 1 Forward Current vs. Ambient Temperature

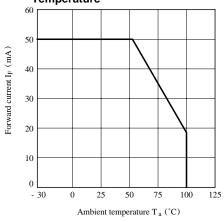
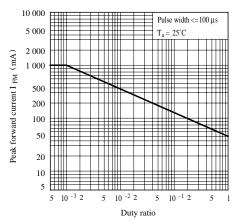
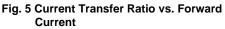
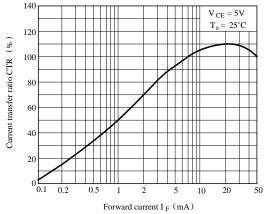


Fig. 3 Peak Forward Current vs. Duty Ratio









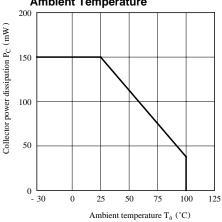


Fig. 4 Forward Current vs. Forward Voltage

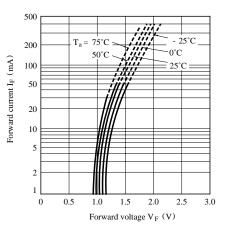
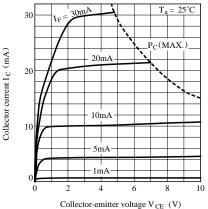
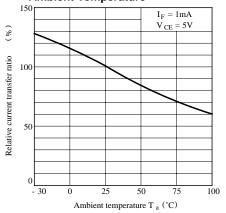


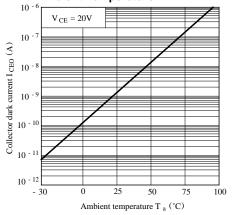
Fig. 6 Collector Current vs. Collector-emitter Voltage



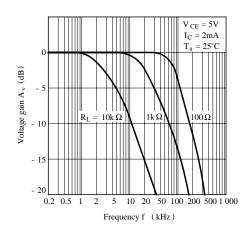


#### Fig. 7 Relative Current Transfer Ratio vs. Ambient Temperature





### Fig.11 Frequency Response





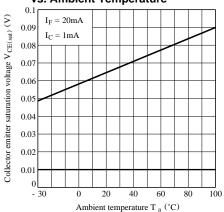
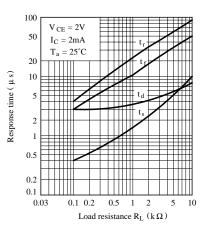
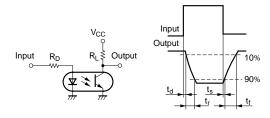
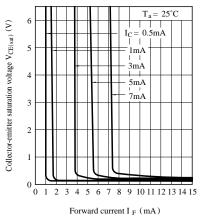


Fig.10 Response Time vs. Load Resistance



**Test Circuit for Response Time** 

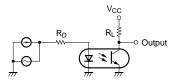




## Fig.12 Collector-emitter Saturation Voltage vs. Forward Current

• Please refer to the chapter "Precautions for Use"

## **Test Circuit for Frepuency Response**



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